PATENT COOPERATION TREATY

From the INTERNATIONAL SEARCHING AUTHORITY

To: MORIMOTO, Yoshihiro All Nippon Airways (Nishi-Hommachi) 4th floor, 10-10, Nishi-Hommachi 1-chome Nishi-ku, Osaka-shi Osaka 550-0005 JAPAN

NOTIFICATION OF TRANSMITTAL OF THE INTERNATIONAL SEARCH REPORT OR THE DECLARATION

(PCT Rule 44.1)

Date of mailing (dav/month/year)

02/04/2002

Applicant's or agent's file reference

PCT3144

FOR FURTHER ACTION

See paragraphs 1 and 4 below

International application No.

International filing date

PCT/JP 01/06230

(day/month/year)

18/07/2001

Applicant

MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD.

1. X The applicant is hereby notified that the International Search Report has been established and is transmitted herewith.

Filing of amendments and statement under Article 19:

The applicant is entitled, if he so wishes, to amend the claims of the International Application (see Rule 46):

The time limit for filing such amendments is normally 2 months from the date of transmittal of the International Search Report; however, for more details, see the notes on the accompanying sheet.

International Bureau of WIPO Where? Directly to the

34, chemin des Colombettes 1211 Geneva 20, Switzerland Fascimile No.: (41-22) 740.14.35

For more detailed instructions, see the notes on the accompanying sheet.

The applicant is hereby notified that no International Search Report will be established and that the declaration under Article 17(2)(a) to that effect is transmitted herewith.

3. With regard to the protest against payment of (an) additional fee(s) under Rule 40.2, the applicant is notified that:

the protest together with the decision thereon has been transmitted to the International Bureau together with the applicant's request to forward the texts of both the protest and the decision thereon to the designated Offices.

no decision has been made yet on the protest; the applicant will be notified as soon as a decision is made.

4. Further action(s): The applicant is reminded of the following:

Shortly after 18 months from the priority date, the international application will be published by the International Bureau. If the applicant wishes to avoid or postpone publication, a notice of withdrawal of the international application, or of the priority claim, must reach the International Bureau as provided in Rules 90bis.1 and 90bis.3, respectively, before the completion of the technical preparations for international publication.

Within 19 months from the priority date, a demand for international preliminary examination must be filed if the applicant wishes to postpone the entry into the national phase until 30 months from the priority date (in some Offices even later).

Within 20 months from the priority date, the applicant must perform the prescribed acts for entry into the national phase before all designated Offices which have not been elected in the demand or in a later election within 19 months from the priority date or could not be elected because they are not bound by Chapter II.

Name and mailing address of the International Searching Authority

European Patent Office, P.B. 5818 Patentlaan 2 NL-2280 HV Rijswijk Tel. (+31-70) 340-2040, Tx. 31 651 epo nl, Fax: (+31-70) 340-3016

Gennaro Cappiello

Authorized officer

Form PCT/ISA/220 (July 1998)

PATENT COOPERATION TREATY

PCT

INTERNATIONAL SEARCH REPORT

(PCT Article 18 and Rules 43 and 44)

Applicant's or agent's file reference	FOR FURTHER see Notification of Transmittal of International Search Report	
PCT3144	ACTION (Form PC1/ISA/2	20) as well as, where applicable, item 5 below.
International application No.	International filing date (day/month/year)	(Earliest) Priority Date (day/month/year)
PCT/JP 01/06230	18/07/2001	21/07/2000
Applicant		
MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD.		
This International Search Report has been prepared by this International Searching Authority and is transmitted to the applicant according to Article 18. A copy is being transmitted to the International Bureau. This International Search Report consists of a total of sheets.		
It is also accompanied by a copy of each prior art document cited in this report.		
1. Basis of the report		
a. With regard to the language, the international search was carried out on the basis of the International application in the language in which it was filed, unless otherwise indicated under this item.		
the International search was carried out on the basis of a translation of the international application furnished to this Authority (Rule 23.1(b)).		
was carried out on the basis of the contained in the internation filed together with the inter turnished subsequently to the statement that the subsinternational application as	sequence listing: nal application in written form, national application in computer readable form this Authority in written form, this Authority in computer readble form, sequently furnished written sequence listing do filed has been furnished.	
2. Certain claims were foun	d unsearchable (See Box I).	
3. Unity of invention is lack	ing (see Box II).	
A With regard to the title		
4. With regard to the title, X the text is approved as sub	mitted by the applicant	
	ed by this Authority to read as follows:	
		
5. With regard to the abstract,		
the text is approved as submitted by the applicant. the text has been established, according to Rule 38.2(b), by this Authority as it appears in Box III. The applicant may, within one month from the date of mailing of this international search report, submit comments to this Authority.		
6. The figure of the drawings to be publis	hed with the abstract is Figure No.	1
as suggested by the application	ant.	None of the figures.
because the applicant faller	**	
because this figure better c	haracterizes the invention.	

Form PCT/ISA/210 (first sheet) (July 1998)

International application No.

INTERNATIONAL SEARCH REPORT

PCT/JP 01/06230

Box III TEXT OF THE ABSTRACT (Continuation of item 5 of the first sheet)

According to the present invention, when a semiconductor element (7) having protruding electrodes(5) formed thereon is connected to a circuit board (1) via Conductive resin(6), stable connection is made even when an electrode pitch is small on the semiconductor element(7). On semiconductor element package regions on the circuit board(1), a paste electrode material(2) containing photopolymerizable materials is printed to form a film having a prescribed thickness, and this electrode material film (2) is baked after exposure and development thereof so as to obtain circuit electrode(4)s having edges warped in a direction of going apart from the circuit board(1) surface. Then, the protruding electrodes(5) and the concave surfaces of the circuit electrodes(4) are brought in abutment with each other and connected via the conductive resin(6) which surrounds the abutments between the respective electrodes(4,5) and is held on the concave surfaces of the circuit electrodes(4). With this arrangement, the concave surfaces of the circuit electrodes(4) act as saucers and prevent the conductive resin(6) from being squeezed out, thereby eliminating possible occurrence of short circuits.